

PWM Fan Speed Controller with FanSense™ Technology

Features

- Temperature Proportional Fan Speed for Acoustic Control and Longer Fan Life
- Efficient PWM Fan Drive
- 3.0V to 5.5V Supply Range:
 - Fan Voltage Independent of TC642 Supply Voltage
 - Supports any Fan Voltage
- FanSense™ Fault Detection Circuits Protect Against Fan Failure and Aid System Testing
- Shutdown Mode for "Green" Systems
- Supports Low Cost NTC/PTC Thermistors
- Space Saving 8-Pin MSOP Package
- Over-temperature Indication

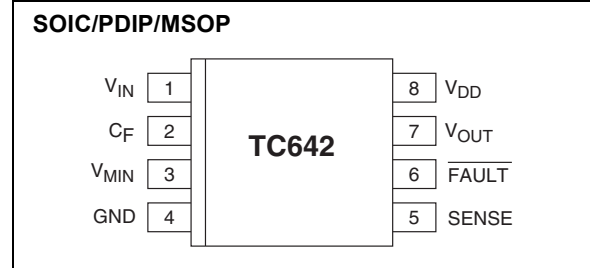
Applications

- Power Supplies
- Personal Computers
- File Servers
- Telecom Equipment
- UPSs, Power Amps, etc.
- General Purpose Fan Speed Control

Available Tools

- Fan Controller Demonstration Board (TC642DEMO)
- Fan Controller Evaluation Kit (TC642EV)

Package Types



General Description

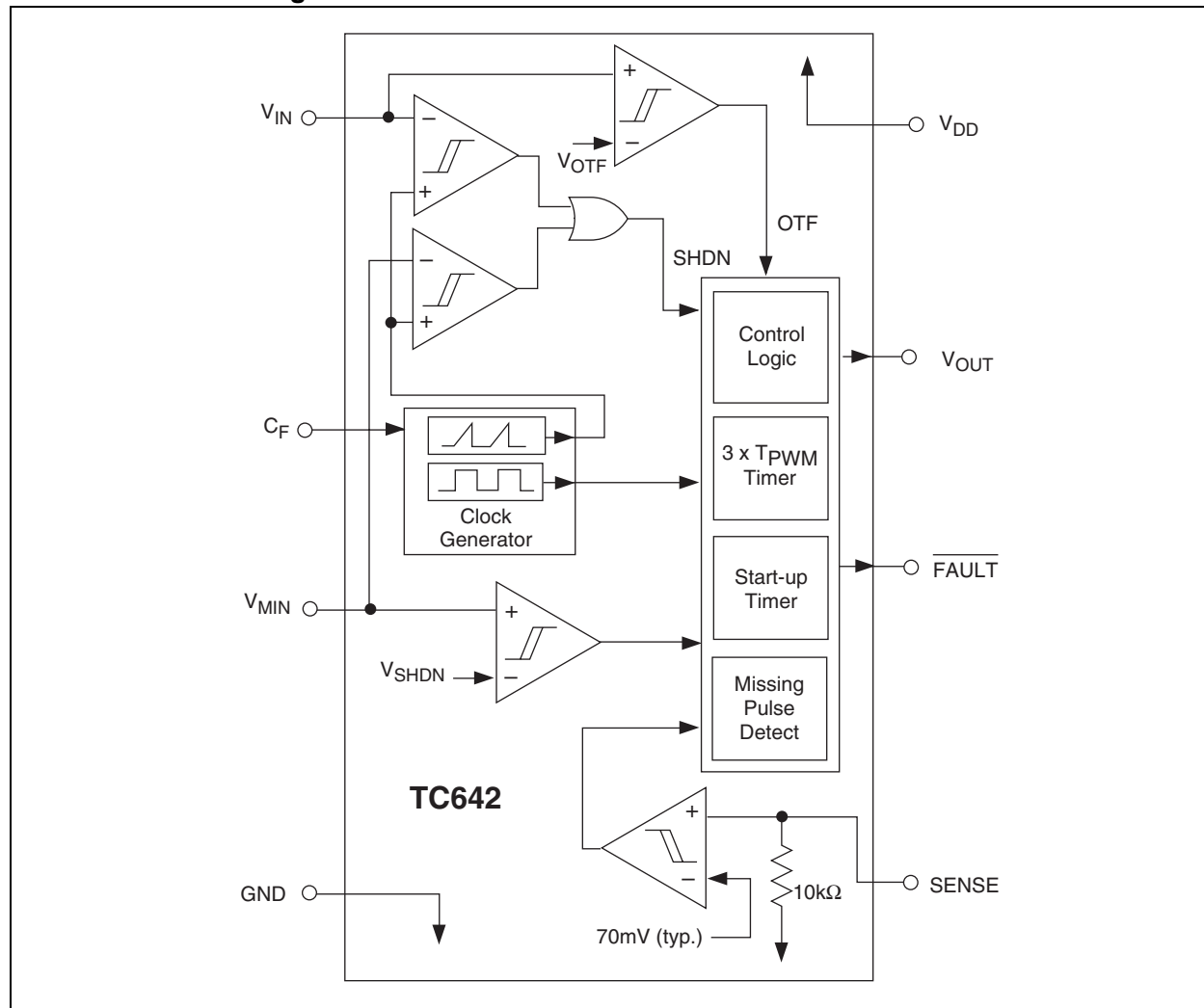
The TC642 is a switch mode fan speed controller for use with brushless DC fans. Temperature proportional speed control is accomplished using pulse width modulation (PWM). A thermistor (or other voltage output temperature sensor) connected to the V_{IN} input furnishes the required control voltage of 1.25V to 2.65V (typical) for 0% to 100% PWM duty cycle. Minimum fan speed is set by a simple resistor divider on the V_{MIN} input. An integrated Start-up Timer ensures reliable motor start-up at turn-on, coming out of shutdown mode or following a transient fault. A logic low applied to V_{MIN} (Pin 3) causes fan shutdown.

The TC642 also features Microchip Technology's proprietary FanSense™ technology for increasing system reliability. In normal fan operation, a pulse train is present at SENSE (Pin 5). A missing pulse detector monitors this pin during fan operation. A stalled, open or unconnected fan causes the TC642 to trigger its Start-up Timer once. If the fault persists, the FAULT output goes low and the device is latched in its shutdown mode. FAULT is also asserted if the PWM reaches 100% duty cycle, indicating a possible thermal runaway situation, although the fan continues to run. See Section 5.0, "Typical Applications", for more information and system design guidelines.

The TC642 is available in the standard 8-pin plastic DIP, SOIC and MSOP packages and is available in the commercial, extended commercial and industrial temperature ranges.

TC642

Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

Supply Voltage 6V
 Input Voltage, Any Pin.... (GND – 0.3V) to (V_{DD} +0.3V)
 Package Thermal Resistance:
 PDIP (R_{θJA})..... 125°C/W
 SOIC (R_{θJA}) 155°C/W
 MSOP (R_{θJA}) 200°C/W
 Specified Temperature Range -40°C to +125°C
 Storage Temperature Range..... -65°C to +150°C

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL SPECIFICATIONS

Electrical Characteristics: T _{MIN} < T _A < T _{MAX} , V _{DD} = 3.0V to 5.5V, unless otherwise specified.						
Symbol	Parameter	Min	Typ	Max	Units	Test Conditions
V _{DD}	Supply Voltage	3.0	—	5.5	V	
I _{DD}	Supply Current, Operating	—	0.5	1.0	mA	Pins 6, 7 Open, C _F = 1 μF, V _{IN} = V _{C(MAX)}
I _{DD(SHDN)}	Supply Current, Shutdown Mode	—	25	—	μA	Pins 6, 7 Open, C _F = 1 μF, V _{MIN} = 0.35V, Note 1
I _{IN}	V _{IN} , V _{MIN} Input Leakage	- 1.0	—	+1.0	μA	Note 1
V_{OUT} Output						
t _R	V _{OUT} Rise Time	—	—	50	μsec	I _{OH} = 5 mA, Note 1
t _F	V _{OUT} Fall Time	—	—	50	μsec	I _{OL} = 1 mA, Note 1
t _{SHDN}	Pulse Width (On V _{MIN}) to Clear Fault Mode	30	—	—	μsec	V _{SHDN} , V _{HYST} Specifications, Note 1
I _{OL}	Sink Current at V _{OUT} Output	1.0	—	—	mA	V _{OL} = 10% of V _{DD}
I _{OH}	Source Current at V _{OUT} Output	5.0	—	—	mA	V _{OH} = 80% of V _{DD}
V_{IN}, V_{MIN} Inputs						
V _{C(MAX)} , V _{OTF}	Input Voltage at V _{IN} or V _{MIN} for 100% PWM Duty Cycle	2.5	2.65	2.8	V	
V _{C(SPAN)}	V _{C(MAX)} - V _{C(MIN)}	1.3	1.4	1.5	V	
V _{SHDN}	Voltage Applied to V _{MIN} to ensure Shutdown Mode	—	—	V _{DD} × 0.13	V	
V _{REL}	Voltage Applied to V _{MIN} to Release Shutdown Mode	V _{DD} × 0.19	—	—	V	V _{DD} = 5V
Pulse Width Modulator						
F _{PWM}	PWM Frequency	26	30	34	Hz	C _F = 1.0 μF
SENSE Input						
V _{TH(SENSE)}	SENSE Input Threshold Voltage with Respect to GND	50	70	90	mV	Note 1
FAULT Output						
V _{OL}	Output Low Voltage	—	—	0.3	V	I _{OL} = 2.5 mA
t _{MP}	Missing Pulse Detector Timer	—	32/F	—	Sec	
t _{STARTUP}	Start-up Timer	—	32/F	—	Sec	
t _{DIAG}	Diagnostic Timer	—	3/F	—	Sec	

Note 1: Ensured by Design, not tested.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No.	Symbol	Description
1	V_{IN}	Analog Input
2	C_F	Analog Output
3	V_{MIN}	Analog Input
4	GND	Ground Terminal
5	SENSE	Analog Input
6	$\overline{\text{FAULT}}$	Digital (Open Collector) Output
7	V_{OUT}	Digital Output
8	V_{DD}	Power Supply Input

2.1 Analog Input (V_{IN})

The thermistor network (or other temperature sensor) connects to the V_{IN} input. A voltage range of 1.25V to 2.65V (typical) on this pin drives an active duty cycle of 0% to 100% on the V_{OUT} pin.

2.2 Analog Output (C_F)

C_F is the positive terminal for the PWM ramp generator timing capacitor. The recommended C_F is 1 μF for 30 Hz PWM operation.

2.3 Analog Input (V_{MIN})

An external resistor divider connected to the V_{MIN} input sets the minimum fan speed by fixing the minimum PWM duty cycle (1.25V to 2.65V = 0% to 100%, typical). The TC642 enters shutdown mode when $V_{MIN} \leq V_{SHDN}$. During shutdown, the $\overline{\text{FAULT}}$ output is inactive and supply current falls to 25 μA (typical). The TC642 exits shutdown mode when $V_{MIN} \geq V_{REL}$ (see Section 5.0, "Typical Applications").

2.4 Ground (GND)

GND denotes the ground terminal.

2.5 Analog Input (SENSE)

Pulses are detected at the SENSE pin as fan rotation chops the current through a sense resistor. The absence of pulses indicates a fault.

2.6 Digital Output ($\overline{\text{FAULT}}$)

The $\overline{\text{FAULT}}$ line goes low to indicate a fault condition. When $\overline{\text{FAULT}}$ goes low due to a fan fault condition, the device is latched in shutdown mode until deliberately cleared or until power is cycled. $\overline{\text{FAULT}}$ may be connected to V_{MIN} if a hard shutdown is desired. $\overline{\text{FAULT}}$ will also be asserted when the PWM reaches 100% duty cycle, indicating that maximum cooling capability has been reached and a possible over-temperature condition may occur. This is a non-latching state and the $\overline{\text{FAULT}}$ output will go high when the PWM duty cycle goes below 100%.

2.7 Digital Output (V_{OUT})

V_{OUT} is an active high complimentary output that drives the base of an external NPN transistor (via an appropriate base resistor) or the gate of an N-channel MOSFET. This output has asymmetrical drive (see Section 1.0, "Electrical Characteristics").

2.8 Power Supply Input (V_{DD})

V_{DD} may be independent of the fan's power supply (see Section 1.0, "Electrical Characteristics").

3.0 DETAILED DESCRIPTION

3.1 PWM

The PWM circuit consists of a ramp generator and threshold detector. The frequency of the PWM is determined by the value of the capacitor connected to the C_F input. A frequency of 30 Hz is recommended ($C_F = 1 \mu F$). The PWM is also the time base for the Start-up Timer (see Section 3.4, "Start-Up Timer"). The PWM voltage control range is 1.25V to 2.65V (typical) for 0% to 100% output duty cycle.

3.2 FAULT Output

The TC642 detects faults in two ways.

First, pulses appearing at SENSE due to the PWM turning on are blanked, with the remaining pulses filtered by a missing pulse detector. If consecutive pulses are not detected for 32 PWM cycles (≈ 1 Sec if $C_F = 1 \mu F$), the Diagnostic Timer is activated, and V_{OUT} is driven high continuously for three PWM cycles (≈ 100 msec if $C_F = 1 \mu F$). If a pulse is not detected within this window, the Start-up Timer is triggered (see Section 3.4). This should clear a transient fault condition. If the missing pulse detector times out again, the PWM is stopped and \overline{FAULT} goes low. When \overline{FAULT} is activated due to this condition, the device is latched in shutdown mode and will remain off indefinitely.

Note: At this point, action *must* be taken to restart the fan by momentarily pulling V_{MIN} below V_{SHDN} , or cycling system power. In either case, the fan *cannot* remain disabled due to a fault condition, as severe system damage could result. If the fan cannot be restarted, the system should be shut down.

The TC642 may be configured to continuously attempt fan restarts, if so desired.

Continuous restart mode is enabled by connecting the \overline{FAULT} output to V_{MIN} through a $0.01 \mu F$ capacitor, as shown in Figure 3-1. When connected in this manner, the TC642 automatically attempts to restart the fan every time a fault condition occurs. When the \overline{FAULT} output is driven low, the V_{MIN} input is momentarily pulled below V_{SHDN} , initiating a reset and clearing the fault condition. Normal fan start-up is then attempted as previously described. The \overline{FAULT} output may be connected to external logic (or the interrupt input of a microcontroller) to shut the TC642 down if multiple fault pulses are detected at approximately one second intervals. Diode D_1 , capacitor C_1 and resistors R_5 and R_6 are provided to ensure fan restarts are the result of a fan fault and not an over-temperature fault. A CMOS logic OR gate may be substituted for these components, if available.

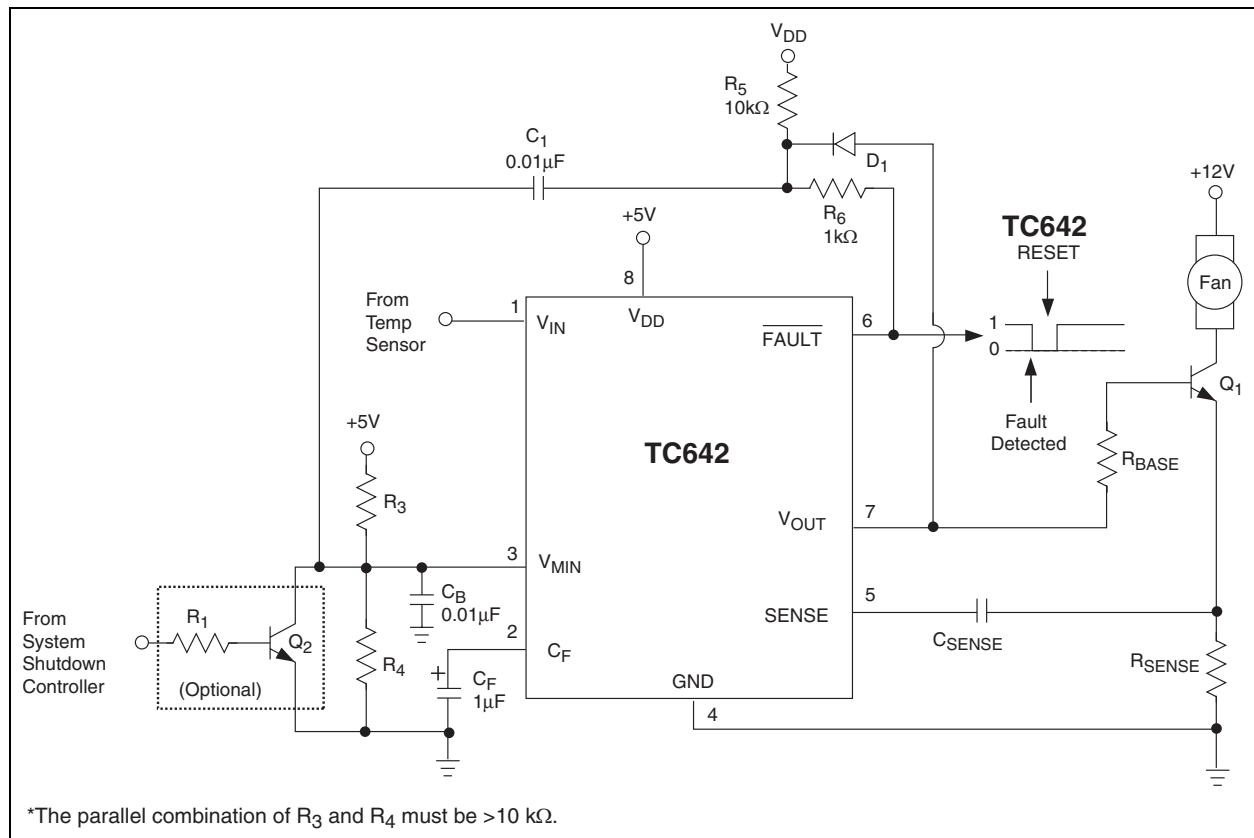


FIGURE 3-1: Fan Fault Output Circuit.

The second condition by which the TC642 detects a fault is when the PWM control voltage applied to V_{IN} becomes greater than that needed to drive 100% duty cycle (see Section 1.0, "Electrical Characteristics"). This indicates that the fan is at maximum drive and the potential exists for system overheating. Either heat dissipation in the system has gone beyond the cooling system's design limits or some subtle fault exists (such as fan bearing failure or an airflow obstruction). This output may be treated as a system overheat warning and be used to trigger system shutdown. However, in this case, the fan will continue to run even when \overline{FAULT} is asserted. If a shutdown is desired, \overline{FAULT} may be connected to V_{MIN} outside the device. This will latch the TC642 in shutdown mode when any fault occurs.

3.3 V_{OUT} Output

The V_{OUT} pin is designed to drive a low cost transistor or MOSFET as the low side power switching element in the system. Various examples of driver circuits will be shown throughout this data sheet. This output has asymmetric complementary drive and is optimized for driving NPN transistors or N-channel MOSFETs. Since the system relies on PWM rather than linear control, the power dissipation in the power switch is kept to a minimum. Generally, very small devices (TO-92 or SOT packages) will suffice.

3.4 Start-Up Timer

To ensure reliable fan start-up, the Start-up Timer turns the V_{OUT} output on for 32 cycles of the PWM whenever the fan is started from the off state. This occurs at power-up and when coming out of shutdown mode. If the PWM frequency is 30 Hz ($C_F = 1 \mu F$), the resulting start-up time will be approximately one second. If a fault is detected, the Diagnostic Timer is triggered once, followed by the Start-up Timer. If the fault persists, the device is shut down (see Section 3.2, " \overline{FAULT} Output").

3.5 Shutdown Control (Optional)

If V_{MIN} (Pin 3) is pulled below V_{SHDN} , the TC642 will go into shutdown mode. This can be accomplished by driving V_{MIN} with an open-drain logic signal or by using an external transistor, as shown in Figure 3-1. All functions are suspended until the voltage on V_{MIN} becomes higher than V_{REL} (0.85V @ $V_{DD} = 5.0V$). Pulling V_{MIN} below V_{SHDN} will always result in complete device shutdown and reset. The \overline{FAULT} output is unconditionally inactive in shutdown mode.

A small amount of hysteresis, typically one percent of V_{DD} (50 mV at $V_{DD} = 5.0V$), is designed into the V_{SHDN} and V_{REL} thresholds. The levels specified for V_{SHDN} and V_{REL} in Section 1.0, "Electrical Characteristics", include this hysteresis, plus adequate margin to account for normal variations in the absolute value of the threshold and hysteresis.

CAUTION: Shutdown mode is unconditional. That is, the fan will not be activated regardless of the voltage at V_{IN} . The fan should not be shut down until all heat producing activity in the system is at a negligible level.

3.6 SENSE Input (FanSense Technology)

The SENSE input (Pin 5) is connected to a low value current sensing resistor in the ground return leg of the fan circuit. During normal fan operation, commutation occurs as each pole of the fan is energized. This causes brief interruptions in the fan current, seen as pulses across the sense resistor. If the device is not in shutdown mode, and pulses are not appearing at the SENSE input, a fault exists.

The short, rapid change in fan current (high dI/dt) causes a corresponding dV/dt across the sense resistor, R_{SENSE} . The waveform on R_{SENSE} is differentiated and converted to a logic-level pulse-train by C_{SENSE} and the internal signal processing circuitry. The presence and frequency of this pulse-train is a direct indication of fan operation (see Section 5.0, "Typical Applications", for more details).

4.0 SYSTEM BEHAVIOR

The flowcharts describing the TC642's behavioral algorithm are shown in Figure 4-1. They can be summarized as follows:

4.1 Power-Up

- (1) Assuming the device is not being held in shutdown mode ($V_{MIN} > V_{REL}$)...
- (2) Turn V_{OUT} output on for 32 cycles of the PWM clock. This ensures that the fan will start from a dead stop.
- (3) During this Start-up Timer, if a fan pulse is detected, branch to Normal Operation; if none are received...
- (4) Activate the 32-cycle Start-up Timer one more time and look for a fan pulse; if a fan pulse is detected, proceed to Normal Operation; if none are received...
- (5) Proceed to Fan Fault.
- (6) End.

4.2 Normal Operation

Normal Operation is an endless loop which may only be exited by entering shutdown mode or Fan Fault. The loop can be thought of as executing at the frequency of the oscillator and PWM.

- (1) Reset the missing pulse detector.
- (2) Is TC642 in shutdown? If so...
 - a. V_{OUT} duty cycle goes to zero.
 - b. \overline{FAULT} is disabled.
 - c. Exit the loop and wait for $V_{MIN} > V_{REL}$ to resume operation (indistinguishable from power-up).
- (3) If an over-temperature fault occurs ($V_{IN} > V_{OTF}$), activate \overline{FAULT} ; release \overline{FAULT} when $V_{IN} < V_{OTF}$.
- (4) Drive V_{OUT} to a duty cycle proportional to the greater of V_{IN} and V_{MIN} on a cycle by cycle basis.
- (5) If a fan pulse is detected, branch back to the start of the loop (1).
- (6) If the missing pulse detector times out ...
- (7) Activate the 3-cycle Diagnostic Timer and look for pulses; if a fan pulse is detected, branch back to the start of the loop (1); if none are received...
- (8) Activate the 32-cycle Start-up Timer and look for pulses; if a fan pulse is detected, branch back to the start of the loop (1); if none are received...
- (9) Quit Normal Operation and go to Fan Fault.
- (10) End.

4.3 Fan Fault

Fan fault is an infinite loop wherein the TC642 is latched in shutdown mode. This mode can only be released by a reset (i.e., V_{MIN} being brought below V_{SHDN} , then above V_{REL} , or by power-cycling).

- (1) While in this state, \overline{FAULT} is latched on (low) and the V_{OUT} output is disabled.
- (2) A reset sequence applied to the V_{MIN} pin will exit the loop to Power-Up.
- (3) End.

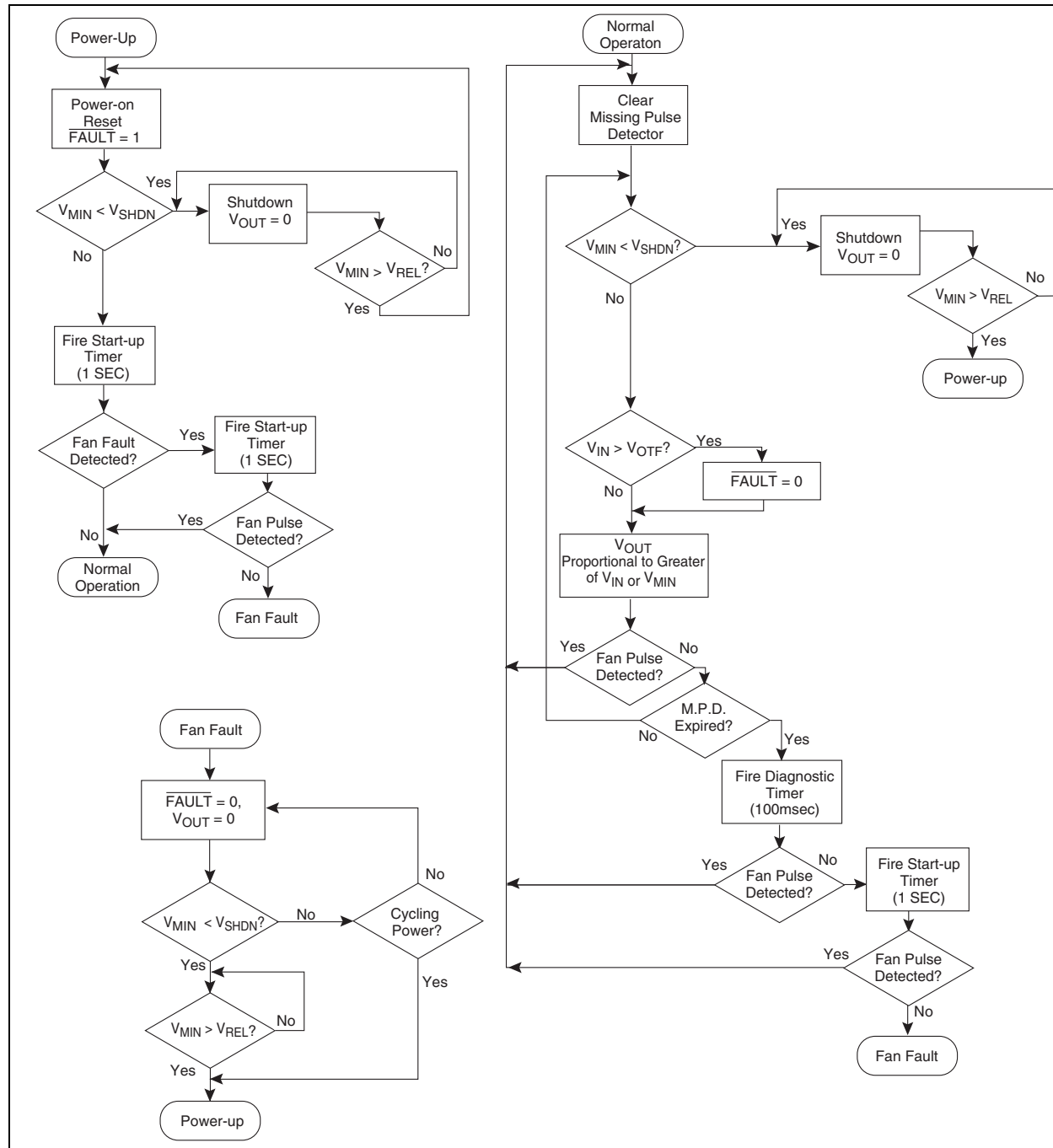


FIGURE 4-1: TC642 Behavioral Algorithm Flowchart.

5.0 TYPICAL APPLICATIONS

Designing with the TC642 involves the following:

- (1) The temp sensor network must be configured to deliver 1.25V to 2.65V on V_{IN} for 0% to 100% of the temperature range to be regulated.
- (2) The minimum fan speed (V_{MIN}) must be set.
- (3) The output drive transistor and associated circuitry must be selected.
- (4) The SENSE network, R_{SENSE} and C_{SENSE} , must be designed for maximum efficiency, while delivering adequate signal amplitude.
- (5) If shutdown capability is desired, the drive requirements of the external signal or circuit must be considered.

The TC642 demonstration and prototyping board (TC642DEMO), and the TC642 Evaluation Kit (TC642EV), provide working examples of TC642 circuits and prototyping aids. The TC642DEMO is a printed circuit board optimized for small size and ease of inclusion into system prototypes. The TC642EV is a larger board intended for benchtop development and analysis. At the very least, anyone contemplating a design using the TC642 should consult the documentation for both TC642EV (DS21403) and TC642DEMO (DS21401).

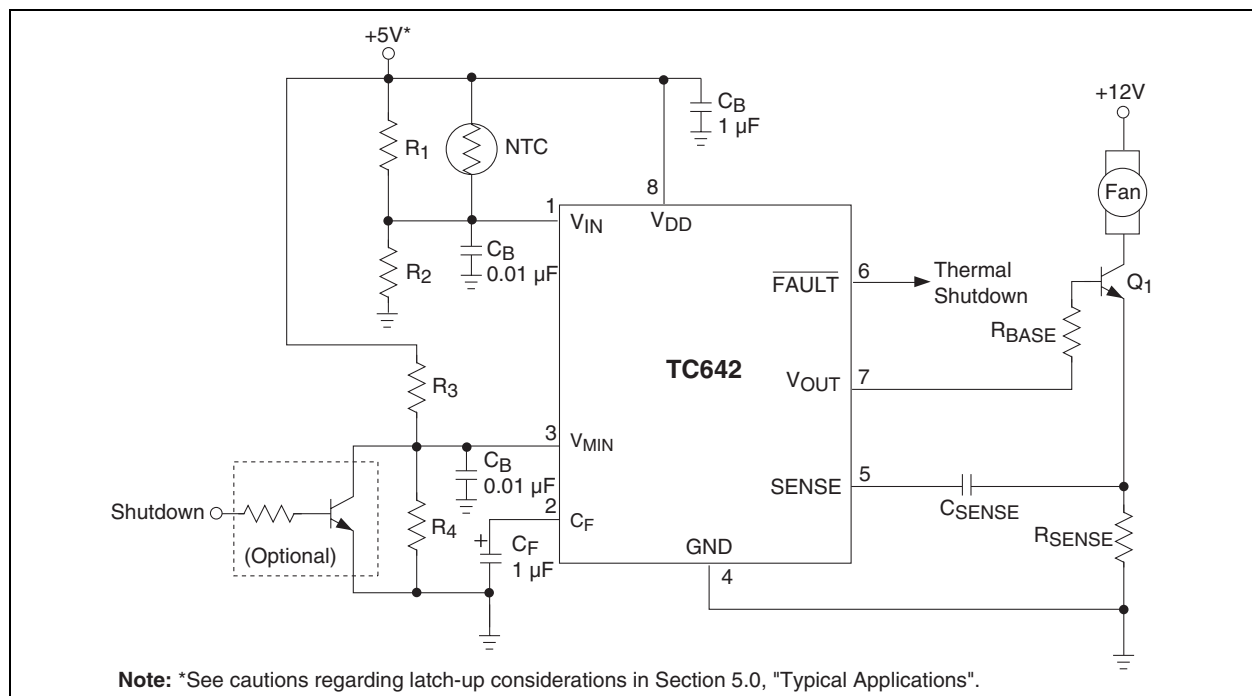


FIGURE 5-1: Typical Application Circuit.

5.1 Temperature Sensor Design

The temperature signal connected to V_{IN} must output a voltage in the range of 1.25V to 2.65V (typical) for 0% to 100% of the temperature range of interest. The circuit in Figure 5-2 illustrates a convenient way to provide this signal.

Figure 5-2 shows a simple temperature dependent voltage divider circuit. RT_1 is a conventional NTC thermistor while R_1 and R_2 are standard resistors. The supply voltage, V_{DD} , is divided between R_2 and the parallel combination of RT_1 and R_1 (for convenience, the parallel combination of RT_1 and R_1 will be referred to as R_{TEMP}). The resistance of the thermistor at various temperatures is obtained from the manufacturer's specifications. Thermistors are often referred to in terms of their resistance at 25°C.

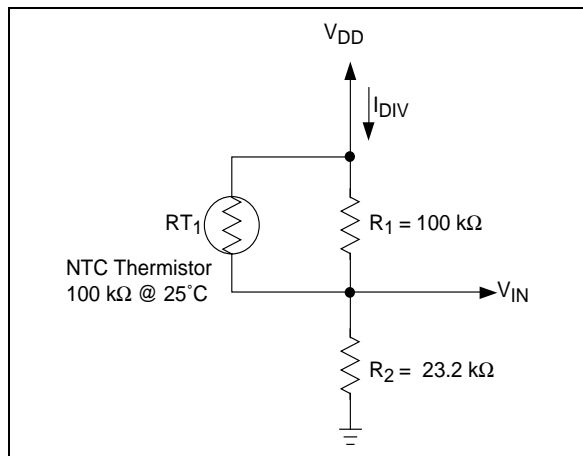


FIGURE 5-2: Temperature Sensing Circuit.

Generally, the thermistor shown in Figure 5-2 is a non-linear device with a negative temperature coefficient (also called an NTC thermistor). In Figure 5-2, R_1 is used to linearize the thermistor temperature response, while R_2 is used to produce a positive temperature coefficient at the V_{IN} node. As an added benefit, this configuration produces an output voltage delta of 1.4V, which is well within the range of the $V_{C(SPAN)}$ specification of the TC642. A 100 kΩ NTC thermistor is selected for this application in order to keep I_{DIV} at a minimum.

For the voltage range at V_{IN} to be equal to 1.25V to 2.65V, the temperature range of this configuration is 0°C to 50°C. If a different temperature range is required from this circuit, R_1 should be chosen to equal the resistance value of the thermistor at the center of this new temperature range. With this change, R_2 is adjusted according to the formulas below. It is suggested that a maximum temperature range of 50°C be used with this circuit due to thermistor linearity limitations.

The following two equations permit solving for the two unknown variables, R_1 and R_2 . More information regarding thermistors can be found in AN679, "Temperature Sensing Technologies", and AN685, "Thermistors in Single Supply Temperature Sensing Circuits", which can be downloaded from Microchip's web site at: www.microchip.com.

EQUATION

$$\frac{V_{DD} \times R_2}{R_{TEMP}(T_1) + R_2} = V(T_1)$$

$$\frac{V_{DD} \times R_2}{R_{TEMP}(T_2) + R_2} = V(T_2)$$

Where T_1 and T_2 are the chosen temperatures and R_{TEMP} is the parallel combination of the thermistor and R_1 .

5.2 Minimum Fan Speed

A voltage divider on V_{MIN} sets the minimum PWM duty cycle and, thus, the minimum fan speed. As with the V_{IN} input, 1.25V to 2.65V typically corresponds to 0% to 100% duty cycle. Assuming that fan speed is linearly related to duty cycle, the minimum speed voltage is given by the equation:

EQUATION

$$V_{MIN} = \frac{\text{Minimum Speed}}{\text{Full Speed}} \times (1.4) + 1.25V$$

For example, if 2500 RPM equates to 100% fan speed, and a minimum speed of 1000 RPM is desired, then the V_{MIN} voltage is:

EQUATION

$$V_{MIN} = \frac{1000}{2500} \times (1.4) + 1.25V = 1.81V$$

The V_{MIN} voltage may be set using a simple resistor divider, as shown in Figure 5-3. Per Section 1.0, "Electrical Characteristics", the leakage current at the V_{MIN} pin is no more than 1 μA. It would be very conservative to design for a divider current, I_{DIV} , of 100 μA. If $V_{DD} = 5.0V$ then;

EQUATION

$$I_{DIV} = 100\mu A = \frac{5.0V}{R_1 + R_2}, \text{ therefore}$$

$$R_1 + R_2 = \frac{5.0V}{100\mu A} = 50,000\Omega = 50k\Omega$$

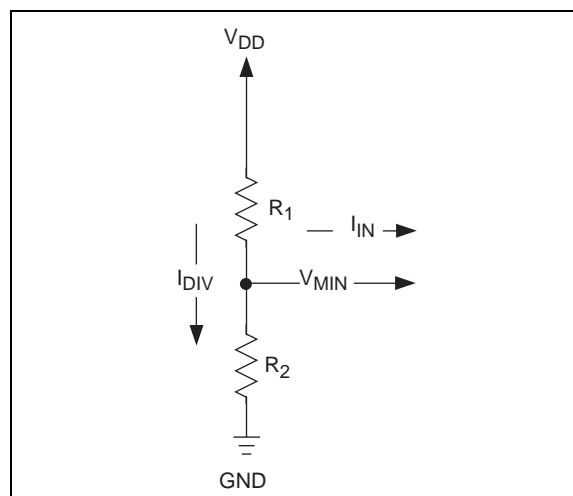


FIGURE 5-3: V_{IN} Circuit.

We can further specify R_1 and R_2 by the condition that the divider voltage is equal to our desired V_{MIN} . This yields the following equation:

EQUATION

$$V_{MIN} = \frac{V_{DD} \times R_2}{R_1 + R_2}$$

Solving for the relationship between R_1 and R_2 results in the following equation:

EQUATION

$$R_1 = R_2 \times \frac{V_{DD} - V_{MIN}}{V_{MIN}}$$

In this example, $R_1 = (1.762) R_2$. Substituting this relationship back into the previous equation yields the resistor values:

$$R_2 = 18.1 \text{ k}\Omega, \text{ and } R_1 = 31.9 \text{ k}\Omega$$

In this case, the standard values of 31.6 k Ω and 18.2 k Ω are very close to the calculated values and would be more than adequate.

5.3 Operations at Low Duty Cycle

One boundary condition which may impact the selection of the minimum fan speed is the irregular activation of the Diagnostic Timer due to the TC642 “missing” fan commutation pulses at low speeds. This is a natural consequence of low PWM duty cycles (typically 25% or less). Recall that the SENSE function detects commutation of the fan as disturbances in the current through R_{SENSE} . These can only occur when the fan is energized (i.e., V_{OUT} is “on”). At very low duty cycles, the V_{OUT} output is “off” most of the time. The fan may be rotating normally, but the commutation events are occurring during the PWM’s off-time.

The phase relationship between the fan’s commutation and the PWM edges tends to “walk around” as the system operates. At certain points, the TC642 may fail to capture a pulse within the 32-cycle missing pulse detector window. When this happens, the 3-cycle Diagnostic Timer will be activated, the V_{OUT} output will be active continuously for three cycles and, if the fan is operating normally, a pulse will be detected. If all is well, the system will return to normal operation. There is no harm in this behavior, but it may be audible to the user as the fan accelerates briefly when the Diagnostic Timer fires. For this reason, it is recommended that V_{MIN} be set no lower than 1.8V.

5.4 FanSense Network (R_{SENSE} and C_{SENSE})

The FanSense network, comprised of R_{SENSE} and C_{SENSE} , allows the TC642 to detect commutation of the fan motor (FanSense technology). This network can be thought of as a differentiator and threshold detector. The function of R_{SENSE} is to convert the fan current into a voltage. C_{SENSE} serves to AC-couple this voltage signal and provide a ground-referenced input to the SENSE pin. Designing a proper SENSE network is simply a matter of scaling R_{SENSE} to provide the necessary amount of gain (i.e., the current-to-voltage conversion ratio). A 0.1 μ F ceramic capacitor is recommended for C_{SENSE} . Smaller values require larger sense resistors, and higher value capacitors are bulkier and more expensive. Using a 0.1 μ F capacitor results in reasonable values for R_{SENSE} . Figure 5-4 illustrates a typical SENSE network. Figure 5-5 shows the waveforms observed using a typical SENSE network.

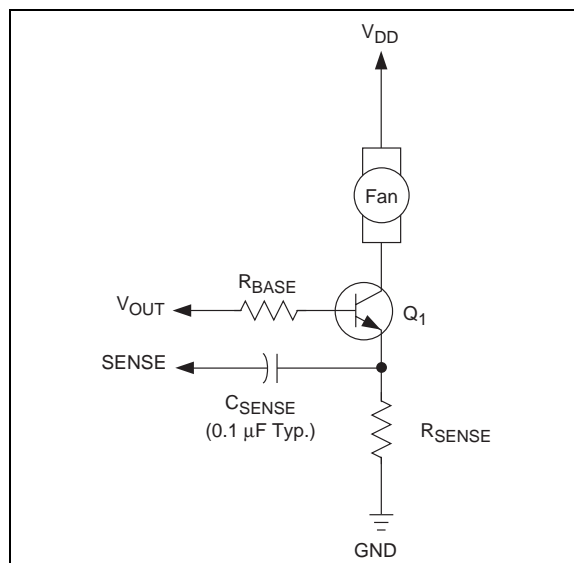


FIGURE 5-4: SENSE Network.

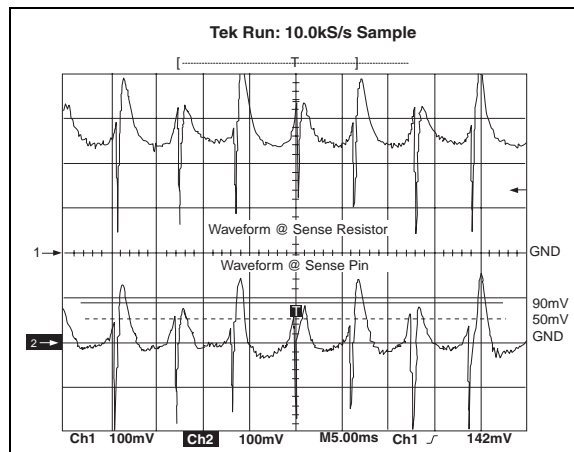


FIGURE 5-5: SENSE Waveforms.

Table 5-1 lists recommended values for R_{SENSE} based on the nominal operating current of the fan. Note that the current draw specified by the fan manufacturer may be a worst-case rating for near-stall conditions and may not be the fan's nominal operating current. The values in Table 5-1 refer to actual average operating current. If the fan current falls between two of the values listed, use the higher resistor value. The end result of employing Table 5-1 is that the signal developed across the sense resistor is approximately 450 mV in amplitude.

TABLE 5-1: R_{SENSE} VS. FAN CURRENT

Nominal Fan Current (mA)	R_{SENSE} (Ω)
50	9.1
100	4.7
150	3.0
200	2.4
250	2.0
300	1.8
350	1.5
400	1.3
450	1.2
500	1.0

5.5 Output Drive Transistor Selection

The TC642 is designed to drive an external transistor or MOSFET for modulating power to the fan. This is shown as Q_1 in Figures 3-1, 5-1, 5-4, 5-6, 5-7, 5-8 and 5-9. The V_{OUT} pin has a minimum source current of 5 mA and a minimum sink current of 1 mA. Bipolar transistors or MOSFETs may be used as the power switching element, as shown in Figure 5-7. When high current gain is needed to drive larger fans, two transistors may be used in a Darlington configuration. Three possible circuit topologies are shown in Figure 5-7: (a) shows a single NPN transistor used as the switching element; (b) illustrates the Darlington pair; and (c) shows an N-channel MOSFET.

One major advantage of the TC642's PWM control scheme versus linear speed control is that the power dissipation in the pass element is kept very low. Generally, low cost devices in very small packages, such as TO-92 or SOT, can be used effectively. For fans with nominal operating currents of no more than 200 mA, a single transistor usually suffices. Above 200 mA, the Darlington or MOSFET solution is recommended. For the fan sensing function to work correctly, it is imperative that the pass transistor be fully saturated when "on".

Table 5-2 gives examples of some commonly available transistors and MOSFETs. This table should be used as a guide only since there are many transistors and MOSFETs which will work just as well as those listed. The critical issues when choosing a device to use as Q_1 are: (1) the breakdown voltage ($V_{(BR)CEO}$ or V_{DS}

(MOSFET)) must be large enough to withstand the highest voltage applied to the fan (**Note:** This will occur when the fan is off); (2) 5 mA of base drive current must be enough to saturate the transistor when conducting the full fan current (transistor must have sufficient gain); (3) the V_{OUT} voltage must be high enough to sufficiently drive the gate of the MOSFET to minimize the $R_{DS(on)}$ of the device; (4) rated fan current draw must be within the transistor's/MOSFET's current handling capability; and (5) power dissipation must be kept within the limits of the chosen device.

A base-current limiting resistor is required with bipolar transistors (Figure 5-6).

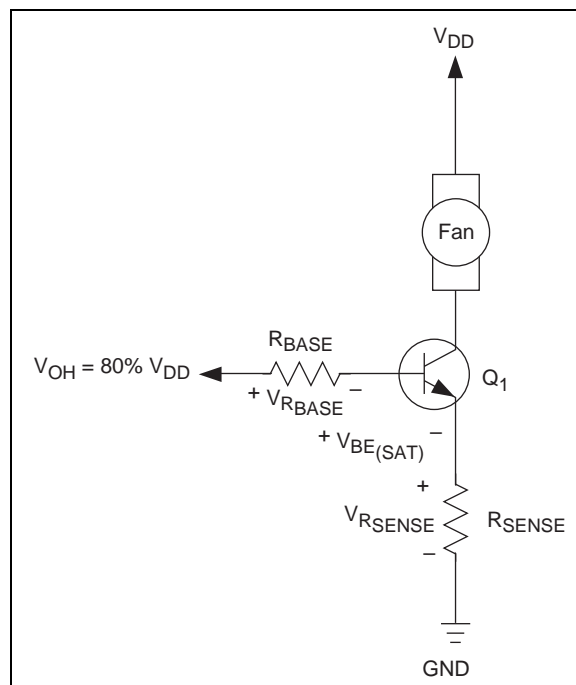


FIGURE 5-6: Circuit For Determining R_{BASE}

The correct value for this resistor can be determined as follows:

$$\begin{aligned}
 V_{OH} &= V_{RSENSE} + V_{BE(SAT)} + V_{RBSE} \\
 V_{RSENSE} &= I_{FAN} \times R_{SENSE} \\
 V_{RBSE} &= R_{BASE} \times I_{BASE} \\
 I_{BASE} &= I_{FAN} / h_{FE}
 \end{aligned}$$

V_{OH} is specified as 80% of V_{DD} in Section 1.0, "Electrical Characteristics"; $V_{BE(SAT)}$ is given in the chosen transistor's data sheet. It is now possible to solve for R_{BASE} .

EQUATION

$$R_{BASE} = \frac{V_{OH} - V_{BE(SAT)} - V_{RSENSE}}{I_{BASE}}$$

Some applications require the fan to be powered from the negative 12V supply to keep motor noise out of the positive voltage power supplies. As is shown in Figure 5-8, zener diode D_1 offsets the -12V power supply voltage, holding transistor Q_1 off when V_{OUT} is low.

When V_{OUT} is high, the voltage at the anode of D_1 increases by V_{OUT} , causing Q_1 to turn on. Operation is otherwise consistent with the case of fan operation from +12V.

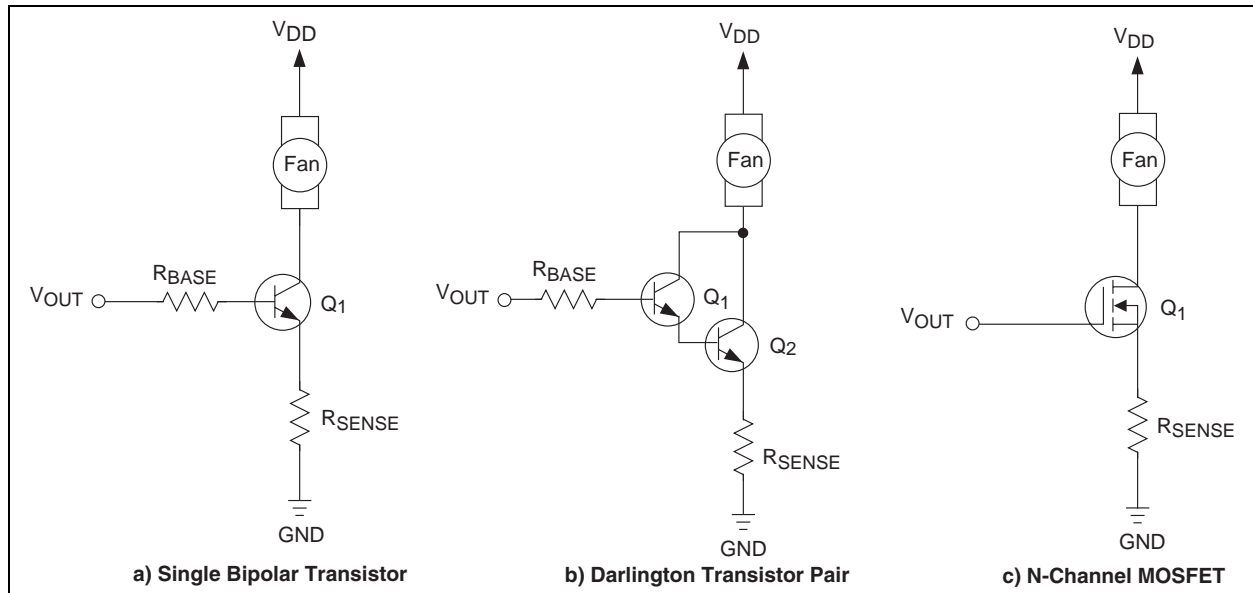


FIGURE 5-7: Output Drive Transistor Circuit Topologies.

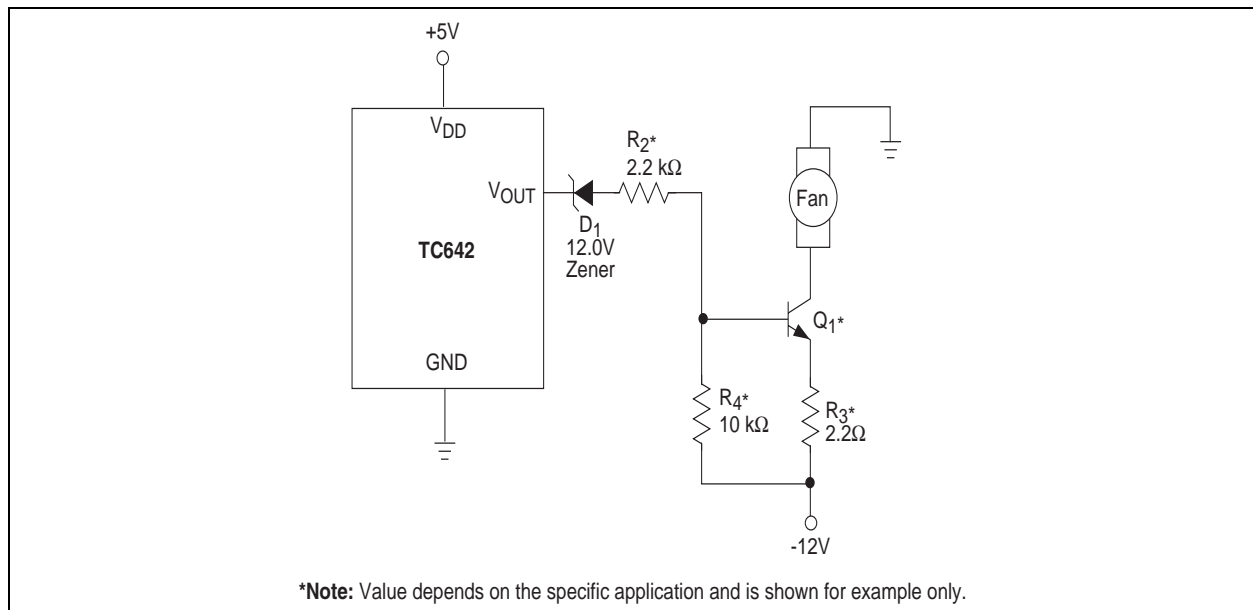


FIGURE 5-8: Powering the Fan From a -12V Supply.

TABLE 5-2: TRANSISTORS AND MOSFETS FOR Q₁ (V_{DD} = 5V)

Device	Package	Max. V _{BE(sat)} /V _{GS} (V)	Min. H _{FE}	V _{CEO} /V _{DS} (V)	Fan Current (mA)	Suggested R _{BASE} (Ω)
MMBT2222A	SOT-23	1.2	50	40	150	800
MPS2222A	TO-92	1.2	50	40	150	800
MPS6602	TO-92	1.2	50	40	500	301
SI2302	SOT-23	2.5	NA	20	500	Note 1
MGSF1N02E	SOT-23	2.5	NA	20	500	Note 1
SI4410	SO-8	4.5	NA	30	1000	Note 1
SI2308	SOT-23	4.5	NA	60	500	Note 1

Note 1: A series gate resistor may be used in order to control the MOSFET turn-on and turn-off times.

5.6 Latch-up Considerations

As with any CMOS IC, the potential exists for latch-up if signals are applied to the device which are outside the power supply range. This is of particular concern during power-up if the external circuitry (such as the sensor network, V_{MIN} divider or shutdown circuit) is powered by a supply different from that of the TC642. Care should be taken to ensure that the TC642's V_{DD} supply powers up first. If possible, the networks attached to V_{IN} and V_{MIN} should connect to the V_{DD} supply at the same physical location as the IC itself. Even if the IC and any external networks are powered by the same supply, physical separation of the connecting points can result in enough parasitic capacitance and/or inductance in the power supply connections to delay one power supply "routing" versus another.

5.7 Power Supply Routing and Bypassing

Noise present on the V_{IN} and V_{MIN} inputs may cause erroneous operation of the FAULT output. As a result, these inputs should be bypassed with a $0.01\ \mu\text{F}$ capacitor mounted as close to the package as is possible. This is particularly true of V_{IN} , which is usually driven from a high impedance source (such as a thermistor). In addition, the V_{DD} input should be bypassed with a $1\ \mu\text{F}$ capacitor. Grounds should be kept as short as possible. To keep fan noise off the TC642 ground pin, individual ground returns for the TC642 and the low side of the fan current sense resistor should be used.

Design Example

Step 1. Calculate R_1 and R_2 based on using an NTC having a resistance of $10\ \text{k}\Omega$ at T_{MIN} (25°C) and $4.65\ \text{k}\Omega$ at T_{MAX} (45°C) (see Figure 5-9).

$$R_1 = 20.5\ \text{k}\Omega$$

$$R_2 = 3.83\ \text{k}\Omega$$

Step 2. Set minimum fan speed $V_{MIN} = 1.8\text{V}$. Limit the divider current to $100\ \mu\text{A}$ from which $R_5 = 33\ \text{k}\Omega$ and $R_6 = 18\ \text{k}\Omega$.

Step 3. Design the output circuit.

Maximum fan motor current = $250\ \text{mA}$.

Q_1 beta is chosen at 50 from which

$$R_7 = 800\ \Omega$$

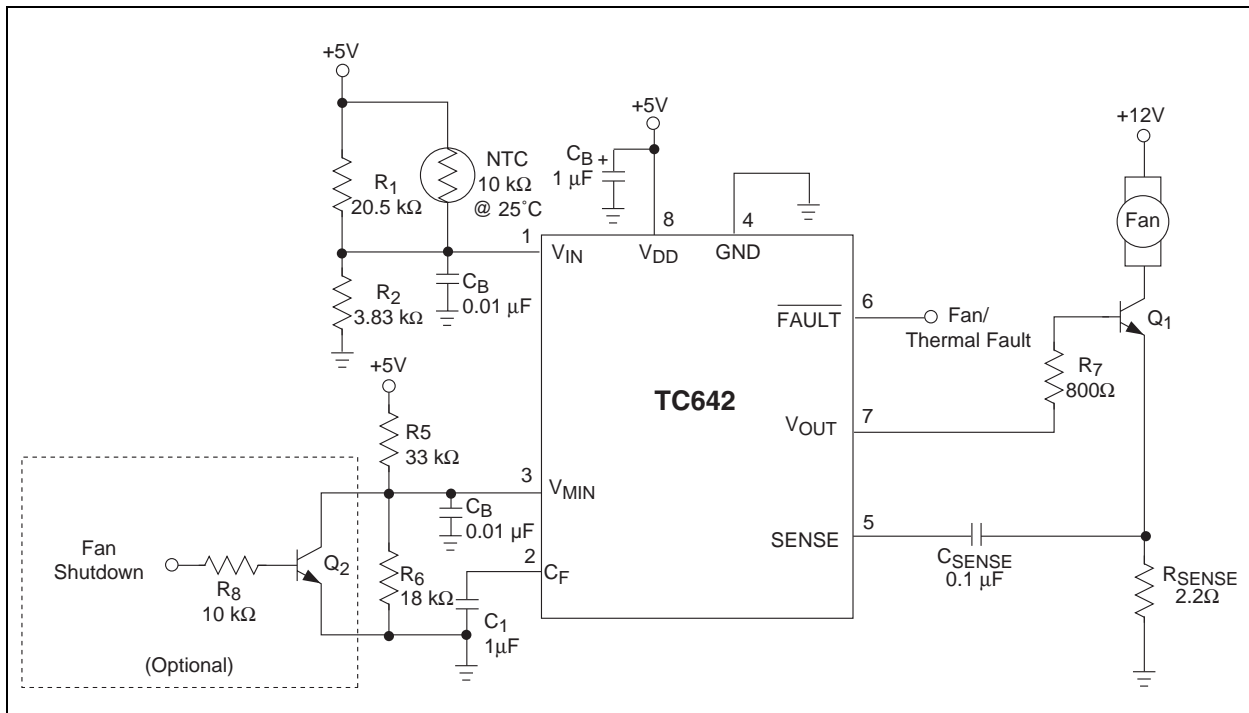


FIGURE 5-9: Design Example.

In a system containing a microcontroller or other host intelligence, the TC642 can be effectively managed as a CPU peripheral. Routine fan control functions can be performed by the TC642 without processor intervention. The microcontroller receives temperature data from one or more points throughout the system. It calculates a fan operating speed based on an algorithm specifically designed for the application at hand. The processor controls fan speed using complementary port bits I/O1 through I/O3. Resistors R₁ through R₆ (5% tolerance) form a crude 3-bit DAC that translates the 3-bit code

With V_{MIN} set to 1.8V, the TC642 has a minimum operating speed of approximately 40% of full rated speed when the processor's output code is 000[B]. Output codes 001[B] to 111[B] operate the fan from roughly 40% to 100% of full speed. An open-drain output from the processor (I/O0) can be used to reset the TC642 following detection of a fault condition. The FAULT output can be connected to the processor's interrupt input, or to an I/O pin, for polled operation.

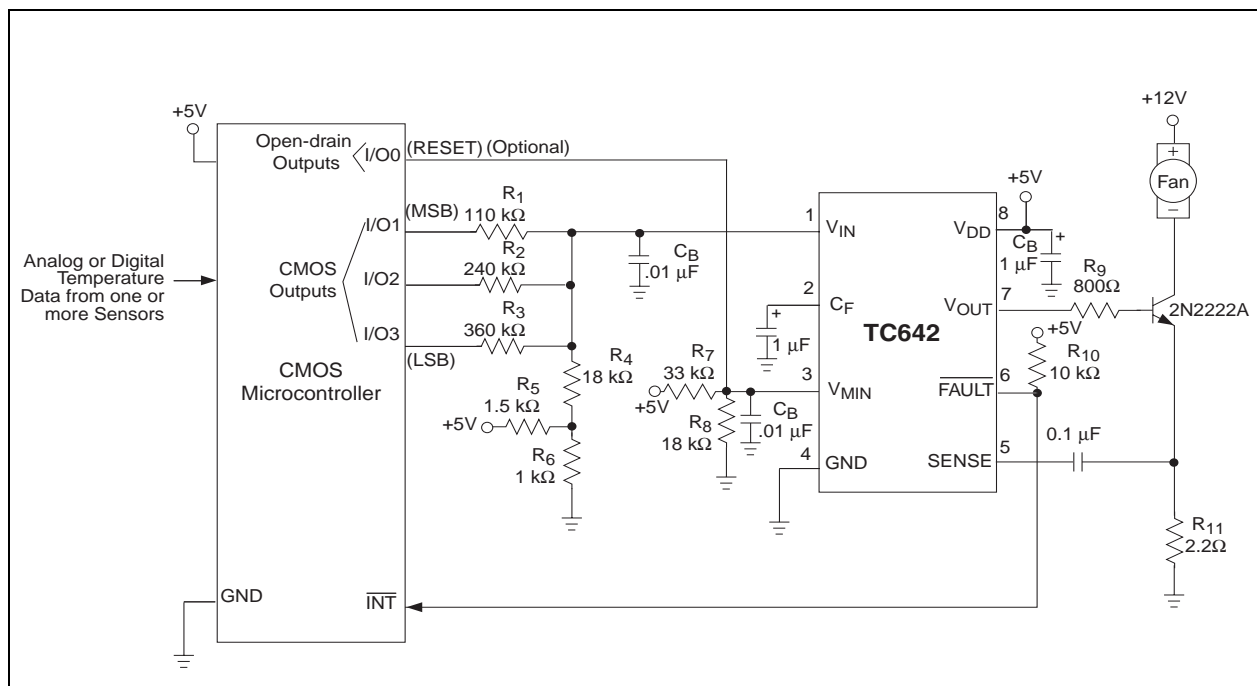
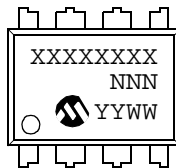


FIGURE 5-10: *TC642 as a Microcontroller Peripheral.*

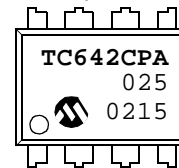
6.0 PACKAGING INFORMATION

6.1 Package Marking Information

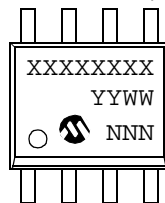
8-Lead PDIP (300 mil)



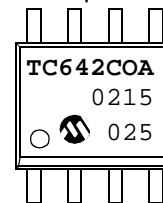
Example:



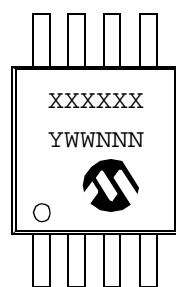
8-Lead SOIC (150 mil)



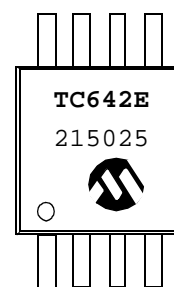
Example:



8-Lead MSOP



Example:



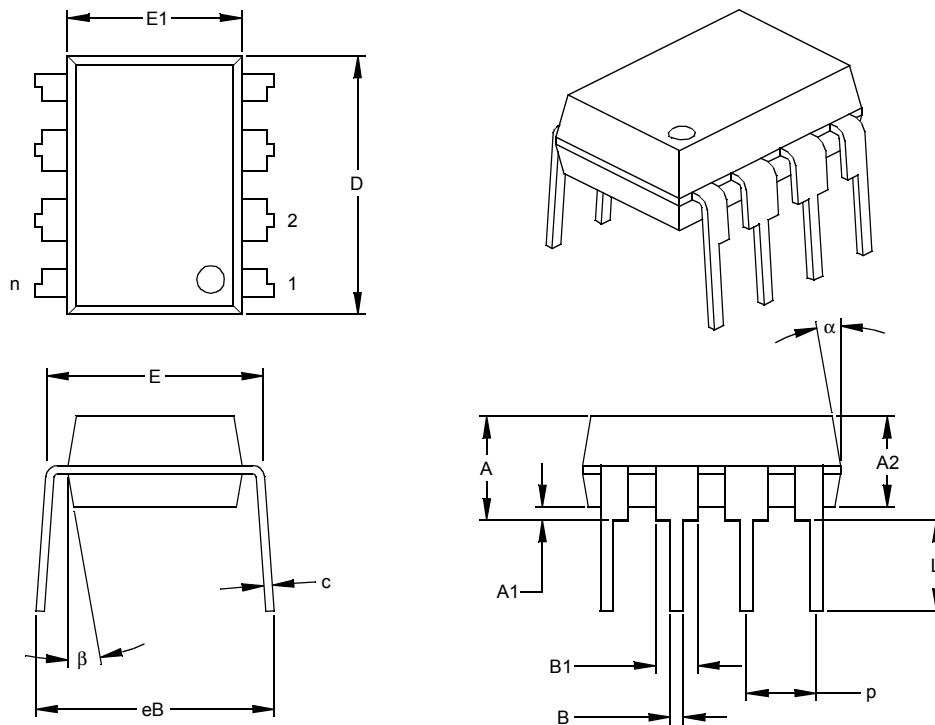
Legend:	XX...X	Customer specific information*
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

- * Standard marking consists of Microchip part number, year code, week code, traceability code (facility code, mask rev#, and assembly code). For marking beyond this, certain price adders apply. Please check with your Microchip Sales Office.

TC642

8-Lead Plastic Dual In-line (P) – 300 mil (PDIP)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.360	.373	.385	9.14	9.46	9.78
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

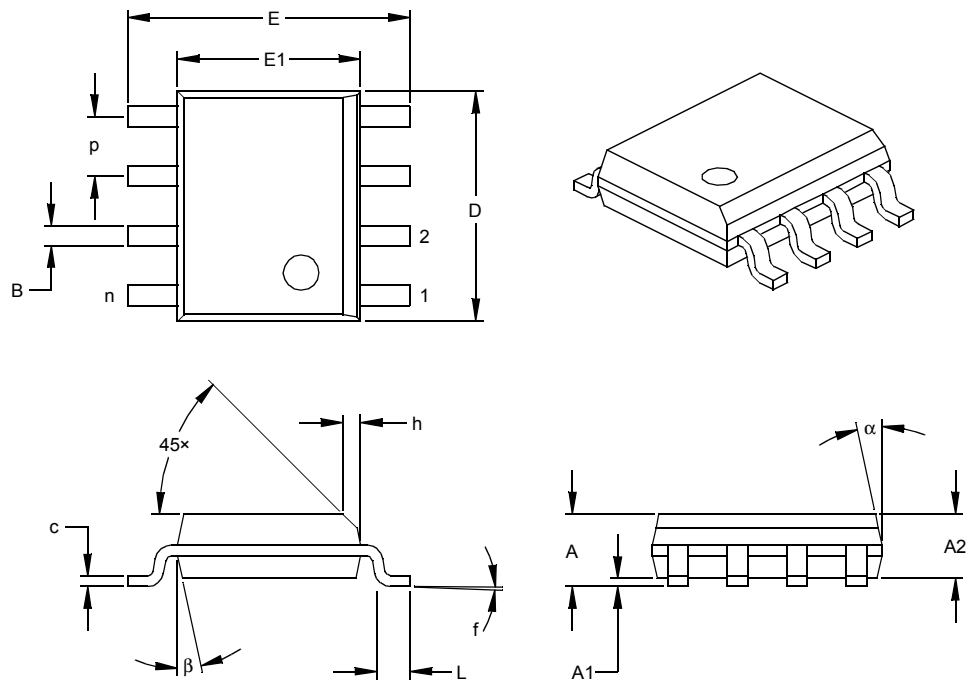
Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-001

Drawing No. C04-018

8-Lead Plastic Small Outline (SN) – Narrow, 150 mil (SOIC)



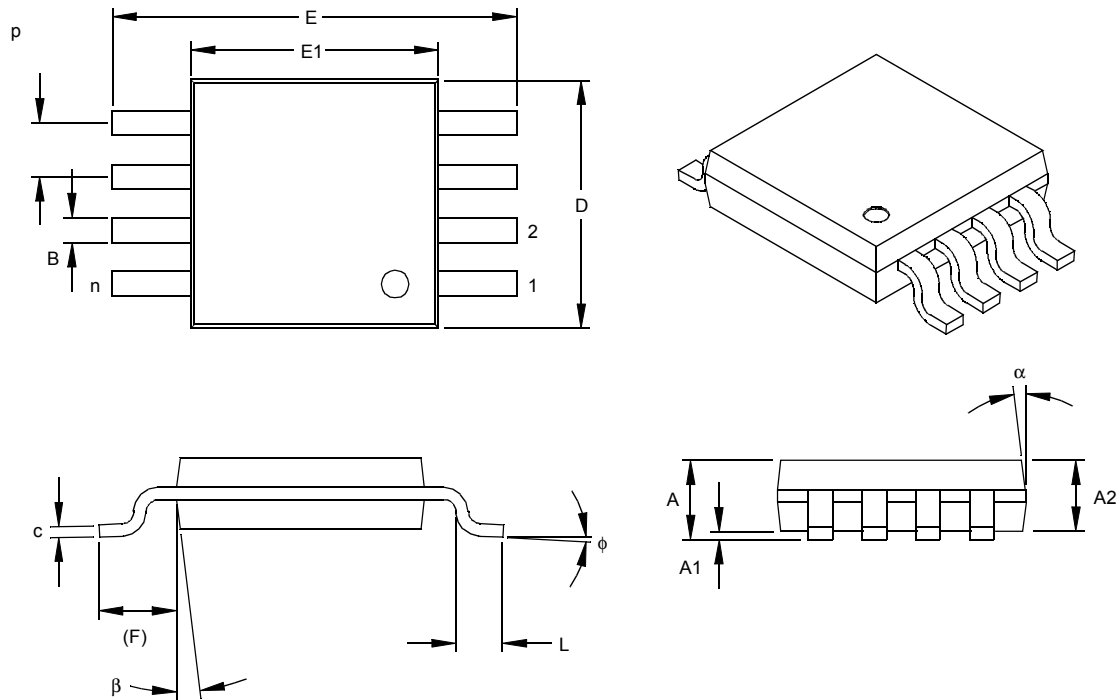
Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.050			1.27	
Overall Height	A	.053	.061	.069	1.35	1.55	1.75
Molded Package Thickness	A2	.052	.056	.061	1.32	1.42	1.55
Standoff §	A1	.004	.007	.010	0.10	0.18	0.25
Overall Width	E	.228	.237	.244	5.79	6.02	6.20
Molded Package Width	E1	.146	.154	.157	3.71	3.91	3.99
Overall Length	D	.189	.193	.197	4.80	4.90	5.00
Chamfer Distance	h	.010	.015	.020	0.25	0.38	0.51
Foot Length	L	.019	.025	.030	0.48	0.62	0.76
Foot Angle	f	0	4	8	0	4	8
Lead Thickness	c	.008	.009	.010	0.20	0.23	0.25
Lead Width	B	.013	.017	.020	0.33	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter
§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.
JEDEC Equivalent: MS-012
Drawing No. C04-057

8-Lead Plastic Micro Small Outline Package (MS) (MSOP)



Units		INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8				8
Pitch	p	.026			0.65		
Overall Height	A			.044			1.18
Molded Package Thickness	A2	.030	.034	.038	0.76	0.86	0.97
Standoff §	A1	.002		.006	0.05		0.15
Overall Width	E	.184	.193	.200	4.67	4.90	5.08
Molded Package Width	E1	.114	.118	.122	2.90	3.00	3.10
Overall Length	D	.114	.118	.122	2.90	3.00	3.10
Foot Length	L	.016	.022	.028	0.40	0.55	0.70
Footprint (Reference)	F	.035	.037	.039	0.90	0.95	1.00
Foot Angle	φ	0		6	0		6
Lead Thickness	c	.004	.006	.008	0.10	0.15	0.20
Lead Width	B	.010	.012	.016	0.25	0.30	0.40
Mold Draft Angle Top	α		7			7	
Mold Draft Angle Bottom	β		7			7	

*Controlling Parameter
§ Significant Characteristic

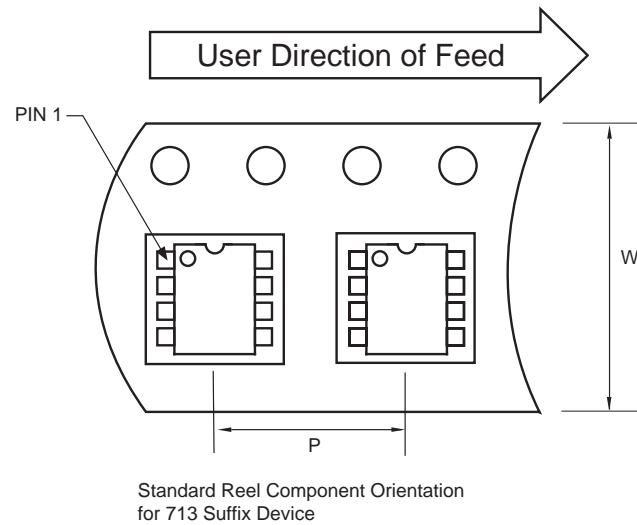
Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

Drawing No. C04-111

6.2 Taping Form

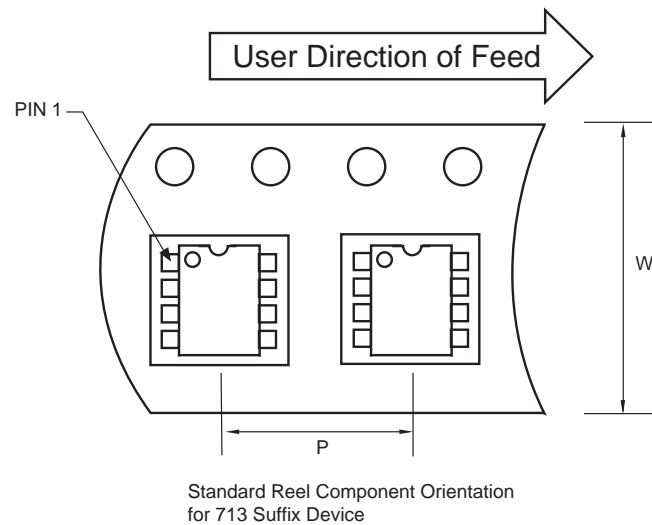
Component Taping Orientation for 8-Pin SOIC (Narrow) Devices



Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin SOIC (N)	12 mm	8 mm	2500	13 in

Component Taping Orientation for 8-Pin MSOP Devices



Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin MSOP	12 mm	8 mm	2500	13 in

TC642

NOTES:

ON-LINE SUPPORT

Microchip provides on-line support on the Microchip World Wide Web site.

The web site is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape® or Microsoft® Internet Explorer. Files are also available for FTP download from our FTP site.

Connecting to the Microchip Internet Web Site

The Microchip web site is available at the following URL:

www.microchip.com

The file transfer site is available by using an FTP service to connect to:

<ftp://ftp.microchip.com>

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- Latest Microchip Press Releases
- Technical Support Section with Frequently Asked Questions
- Design Tips
- Device Errata
- Job Postings
- Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products
- Conferences for products, Development Systems, technical information and more
- Listing of seminars and events

SYSTEMS INFORMATION AND UPGRADE HOT LINE

The Systems Information and Upgrade Line provides system users a listing of the latest versions of all of Microchip's development systems software products. Plus, this line provides information on how customers can receive the most current upgrade kits. The Hot Line Numbers are:

1-800-755-2345 for U.S. and most of Canada, and

1-480-792-7302 for the rest of the world.

092002

READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

To: Technical Publications Manager
RE: Reader Response
Total Pages Sent _____
From: Name _____
Company _____
Address _____
City / State / ZIP / Country _____
Telephone: (_____) _____ - _____ FAX: (_____) _____ - _____

Application (optional):

Would you like a reply? ____Y ____N

Device: **TC642** Literature Number: **DS21444C**

Questions:

1. What are the best features of this document?

2. How does this document meet your hardware and software development needs?

3. Do you find the organization of this document easy to follow? If not, why?

4. What additions to the document do you think would enhance the structure and subject?

5. What deletions from the document could be made without affecting the overall usefulness?

6. Is there any incorrect or misleading information (what and where)?

7. How would you improve this document?

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>
Device	Temperature Range	Package
Device:	TC642:	PWM Fan Speed Controller w/ Fault Detection
Temperature Range:	C = 0°C to +70°C V = 0°C to +85°C E = -40°C to +85°C	
Package:	PA = Plastic DIP (300 mil Body), 8-lead * OA = Plastic SOIC, (150 mil Body), 8-lead UA = Plastic Micro Small Outline (MSOP), 8-lead **	
	* PDIP is only offered in the C and V temp ranges ** MSOP is only available in the V and E temp ranges	

Examples:

- TC642COA: PWM Fan Speed Controller w/ Fault Detection, SOIC package.
- TC642COA713: PWM Fan Speed Controller w/ Fault Detection, SOIC package, Tape and Reel.
- TC642CPA: PWM Fan Speed Controller w/ Fault Detection, PDIP package.
- TC642EUA: PWM Fan Speed Controller w/ Fault Detection, MSOP package.

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- Your local Microchip sales office
- The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
- The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System

Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

NOTES:

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, KEELOQ, MPLAB, PIC, PICmicro, PICSTART and PRO MATE are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.


FilterLab, microID, MXDEV, MXLAB, PICMASTER, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

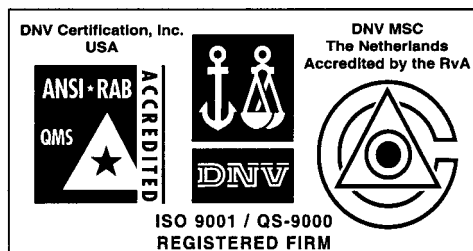
dsPIC, dsPICDEM.net, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, PICC, PICDEM, PICDEM.net, rPIC, Select Mode and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

Serialized Quick Turn Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2002, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.



Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999 and Mountain View, California in March 2002. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, non-volatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.

WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200 Fax: 480-792-7277
Technical Support: 480-792-7627
Web Address: <http://www.microchip.com>

Rocky Mountain

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7966 Fax: 480-792-4338

Atlanta

500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston

2 Lan Drive, Suite 120
Westford, MA 01886
Tel: 978-692-3848 Fax: 978-692-3821

Chicago

333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas

4570 Westgrove Drive, Suite 160
Addison, TX 75001
Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Tri-Atria Office Building
32255 Northwestern Highway, Suite 190
Farmington Hills, MI 48334
Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

2767 S. Albright Road
Kokomo, Indiana 46902
Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 949-263-1888 Fax: 949-263-1338

New York

150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 631-273-5305 Fax: 631-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

Toronto

6285 Northam Drive, Suite 108
Mississauga, Ontario L4V 1X5, Canada
Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia

Microchip Technology Australia Pty Ltd
Suite 22, 41 Rawson Street
Epping 2121, NSW
Australia
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Microchip Technology Consulting (Shanghai)
Co., Ltd., Beijing Liaison Office
Unit 915
Bei Hai Wan Tai Bldg.
No. 6 Chaoyangmen Beidajie
Beijing, 100027, No. China
Tel: 86-10-85282100 Fax: 86-10-85282104

China - Chengdu

Microchip Technology Consulting (Shanghai)
Co., Ltd., Chengdu Liaison Office
Rm. 2401, 24th Floor,
Ming Xing Financial Tower
No. 88 TIDU Street
Chengdu 610016, China
Tel: 86-28-86766200 Fax: 86-28-86766599

China - Fuzhou

Microchip Technology Consulting (Shanghai)
Co., Ltd., Fuzhou Liaison Office
Unit 28F, World Trade Plaza
No. 71 Wusi Road
Fuzhou 350001, China
Tel: 86-591-7503506 Fax: 86-591-7503521

China - Shanghai

Microchip Technology Consulting (Shanghai)
Co., Ltd.
Room 701, Bldg. B
Far East International Plaza
No. 317 Xian Xia Road
Shanghai, 200051
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

China - Shenzhen

Microchip Technology Consulting (Shanghai)
Co., Ltd., Shenzhen Liaison Office
Rm. 1315, 13/F, Shenzhen Kerry Centre,
Renminnan Lu
Shenzhen 518001, China
Tel: 86-755-2350361 Fax: 86-755-2366086

China - Hong Kong SAR

Microchip Technology Hongkong Ltd.
Unit 901-6, Tower 2, Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2401-1200 Fax: 852-2401-3431

India

Microchip Technology Inc.
India Liaison Office
Divyasree Chambers
1 Floor, Wing A (A3/A4)
No. 11, O'Shaugnessey Road
Bangalore, 560 025, India
Tel: 91-80-2290061 Fax: 91-80-2290062

Japan

Microchip Technology Japan K.K.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa, 222-0033, Japan
Tel: 81-45-471-6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea 135-882
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Singapore

Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore, 188980
Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan

Microchip Technology (Barbados) Inc.,
Taiwan Branch
11F-3, No. 207
Tung Hua North Road
Taipei, 105, Taiwan
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Austria

Microchip Technology Austria GmbH
Durisolstrasse 2
A-4600 Wels
Austria
Tel: 43-7242-2244-399
Fax: 43-7242-2244-393

Denmark

Microchip Technology Nordic ApS
Regus Business Centre
Lautrup høj 1-3
Ballerup DK-2750 Denmark
Tel: 45 4420 9895 Fax: 45 4420 9910

France

Microchip Technology SARL
Parc d'Activite du Moulin de Massy
43 Rue du Saule Trapu
Batiment A - 1er Etage
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Microchip Technology GmbH
Steinheilstrasse 10
D-85737 Ismaning, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

United Kingdom

Microchip Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44 118 921 5869 Fax: 44-118 921-5820